

- 'AS1004A Offer High Capacitive-Drive Capability
- Driver Version of 'ALS04B and 'AS04
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

### description

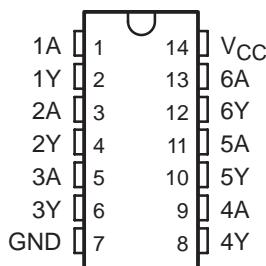
These devices contain six independent inverting drivers. They perform the Boolean function  $Y = \bar{A}$ .

The SN54AS1004A is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74ALS1004 and SN74AS1004A are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

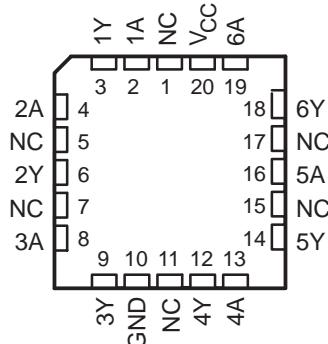
FUNCTION TABLE  
(each inverter)

INPUT A	OUTPUT Y
H	L
L	H

SN54AS1004A . . . J PACKAGE  
SN74ALS1004, SN74AS1004A . . . D OR N PACKAGE  
(TOP VIEW)

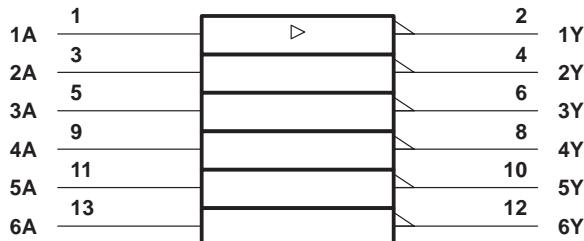


SN54AS1004A . . . FK PACKAGE  
(TOP VIEW)



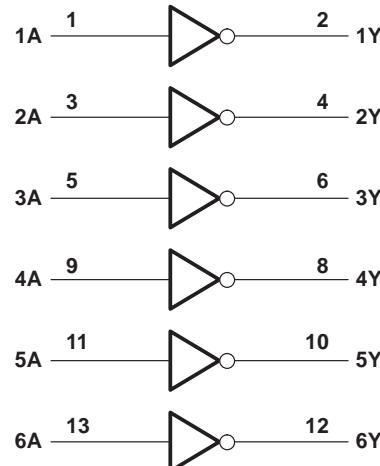
NC – No internal connection

### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for the D, J, and N packages.

### logic diagram (positive logic)



# SN54AS1004A, SN74ALS1004, SN74AS1004A HEX INVERTING DRIVERS

SDAS074B – APRIL 1982 – REVISED JANUARY 1995

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage, $V_{CC}$ .....	7 V
Input voltage, $V_I$ .....	7 V
Operating free-air temperature range, $T_A$ : SN74ALS1004 .....	0°C to 70°C
Storage temperature range .....	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## recommended operating conditions

		SN74ALS1004			UNIT
		MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$I_{OH}$	High-level output current			-15	mA
$I_{OL}$	Low-level output current			24	mA
$T_A$	Operating free-air temperature	0	70		°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN74ALS1004			UNIT
		MIN	TYP <sup>‡</sup>	MAX	
$V_{IK}$	$V_{CC} = 4.5$ V, $I_I = -18$ mA			-1.5	V
$V_{OH}$	$V_{CC} = 4.5$ V to 5.5 V, $I_{OH} = -0.4$ mA	$V_{CC} - 2$			V
	$V_{CC} = 4.5$ V	$I_{OH} = -3$ mA	2.4	3.2	
		$I_{OH} = -15$ mA	2		
$V_{OL}$	$V_{CC} = 4.5$ V	$I_{OL} = 12$ mA	0.25	0.4	V
		$I_{OL} = 24$ mA	0.35	0.5	
$I_I$	$V_{CC} = 5.5$ V, $V_I = 7$ V			0.1	mA
$I_{IH}$	$V_{CC} = 5.5$ V, $V_I = 2.7$ V			20	μA
$I_{IL}$	$V_{CC} = 5.5$ V, $V_I = 0.4$ V			-0.1	mA
$I_O$ <sup>§</sup>	$V_{CC} = 5.5$ V, $V_O = 2.25$ V	-30		-112	mA
$I_{CCH}$	$V_{CC} = 5.5$ V, $V_I = 0$		0.84	3	mA
$I_{CCL}$	$V_{CC} = 5.5$ V, $V_I = 4.5$ V		7	12	mA

<sup>†</sup> All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

<sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current,  $I_{OS}$ .

## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ V to 5.5 V, $C_L = 50$ pF, $R_L = 500$ Ω, $T_A = \text{MIN to MAX}$ <sup>¶</sup>	UNIT	
			SN74ALS1004		
			MIN	MAX	
$t_{PLH}$	A	Y	1	7	ns
			1	6	

<sup>¶</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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# SN54AS1004A, SN74ALS1004, SN74AS1004A HEX INVERTING DRIVERS

SDAS074B – APRIL 1982 – REVISED JANUARY 1995

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions<sup>‡</sup>

		SN54AS1004A			SN74AS1004A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage		2		2			V
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V
I <sub>OH</sub>	High-level output current			-40			-48	mA
I <sub>OL</sub>	Low-level output current			40			48	mA
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

<sup>†</sup>These high sink- or source-current devices are not recommended for use above 40 MHz.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54AS1004A			SN74AS1004A			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
$V_{IK}$	$V_{CC} = 4.5 \text{ V}$ , $I_I = -18 \text{ mA}$		-1.2			-1.2		V
$V_{OH}$	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ , $I_{OH} = -2 \text{ mA}$	$V_{CC} - 2$			$V_{CC} - 2$			V
	$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2	
		$I_{OH} = -40 \text{ mA}$	2					
		$I_{OH} = -48 \text{ mA}$				2		
$V_{OL}$	$V_{CC} = 4.5 \text{ V}$	$I_{OL} = 40 \text{ mA}$	0.25	0.5				V
		$I_{OL} = 48 \text{ mA}$				0.35	0.5	
$I_I$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 7 \text{ V}$		0.1			0.1		mA
$I_{IH}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 2.7 \text{ V}$		20			20		$\mu\text{A}$
$I_{IL}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 0.4 \text{ V}$		-0.5			-0.5		mA
$I_O^{\uparrow}$	$V_{CC} = 5.5 \text{ V}$ , $V_O = 2.25 \text{ V}$	-50	-200		-50	-200		mA
$I_{CCH}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 0$	3.5	5		3.5	5		mA
$I_{CCI}$	$V_{CC} = 5.5 \text{ V}$ , $V_I = 4.5 \text{ V}$	16	27		16	27		mA

§ All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

1 The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current,  $I_{OS}$ .

# SN54AS1004A, SN74ALS1004, SN74AS1004A HEX INVERTING DRIVERS

SDAS074B – APRIL 1982 – REVISED JANUARY 1995

## switching characteristics (see Figure 1)

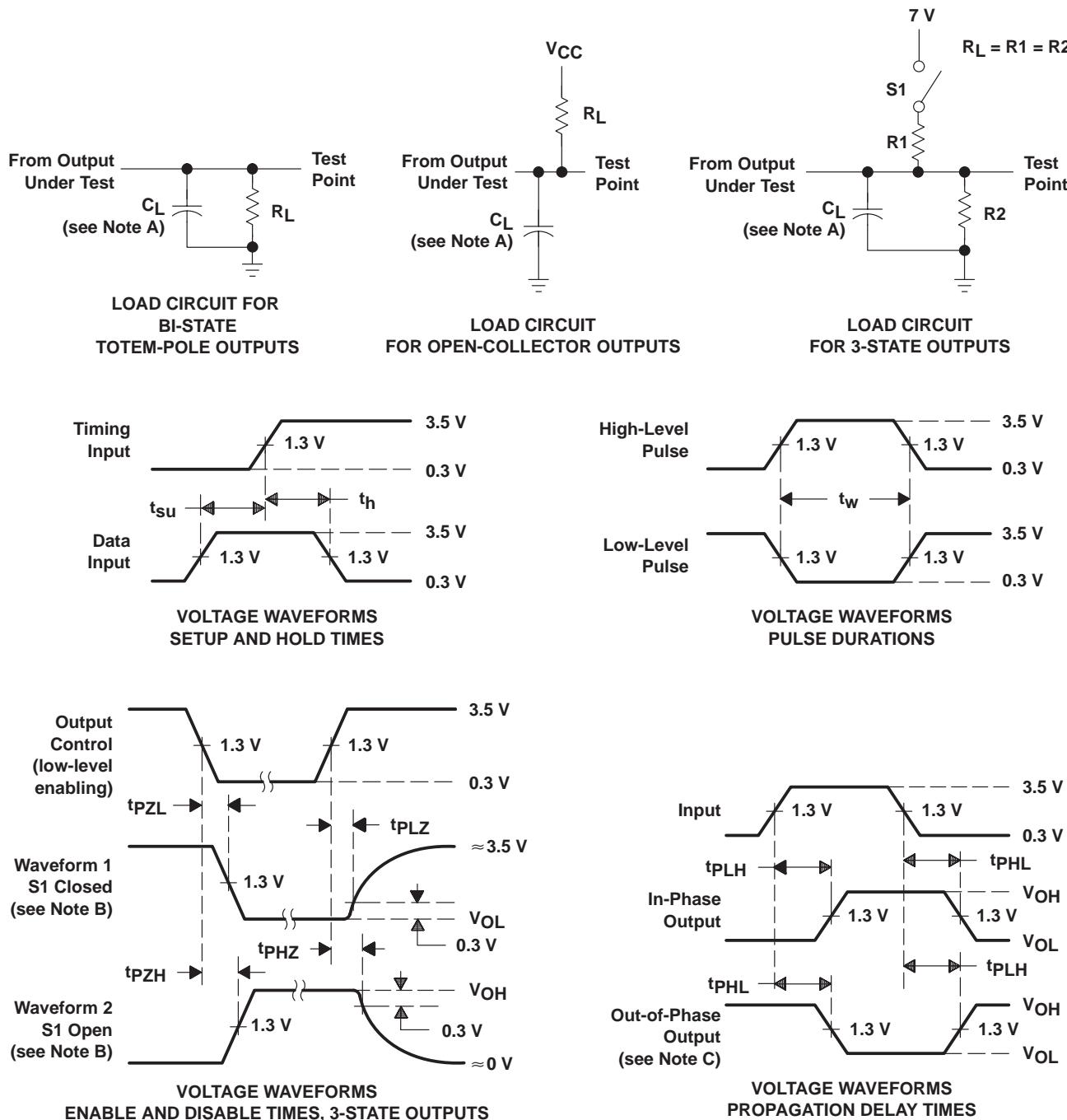
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ , $C_L = 50 \text{ pF}$ , $R_L = 500 \Omega$ , $T_A = \text{MIN to MAX}^\dagger$				UNIT	
			SN54AS1004A		SN74AS1004A			
			MIN	MAX	MIN	MAX		
$t_{PLH}$	A	Y	1	5	1	4	ns	
			1	5	1	4		

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION  
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.  
 D. All input pulses have the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $t_r = t_f = 2 \text{ ns}$ , duty cycle = 50%.  
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-88729012A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-88729012A SNJ54AS1004AFK
5962-8872901CA	Active	Production	CDIP (J)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901CA SNJ54AS1004AJ
5962-8872901DA	Active	Production	CFP (W)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901DA SNJ54AS1004AW
SN54AS1004AJ	Active	Production	CDIP (J)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS1004AJ
SN54AS1004AJ.A	Active	Production	CDIP (J)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54AS1004AJ
SN74ALS1004D	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1004
SN74ALS1004D.A	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1004
SN74ALS1004N	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS1004N
SN74ALS1004N.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS1004N
SN74ALS1004NSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1004
SN74ALS1004NSR.A	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS1004
SN74AS1004AD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	AS1004A
SN74AS1004ADR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS1004A
SN74AS1004ADR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS1004A
SN74AS1004AN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS1004AN
SN74AS1004AN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS1004AN
SN74AS1004AN.B	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS1004AN
SN74AS1004ANSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS1004A
SN74AS1004ANSR.A	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS1004A
SNJ54AS1004AFK	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-88729012A SNJ54AS1004AFK
SNJ54AS1004AFK.A	Active	Production	LCCC (FK)   20	55   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-88729012A SNJ54AS1004AFK

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SNJ54AS1004AJ</a>	Active	Production	CDIP (J)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901CA SNJ54AS1004AJ
SNJ54AS1004AJ.A	Active	Production	CDIP (J)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901CA SNJ54AS1004AJ
<a href="#">SNJ54AS1004AW</a>	Active	Production	CFP (W)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901DA SNJ54AS1004AW
SNJ54AS1004AW.A	Active	Production	CFP (W)   14	25   TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8872901DA SNJ54AS1004AW

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

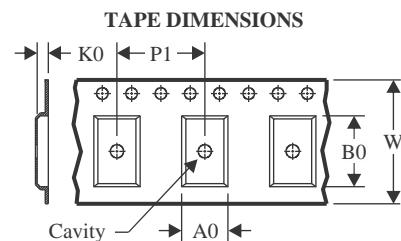
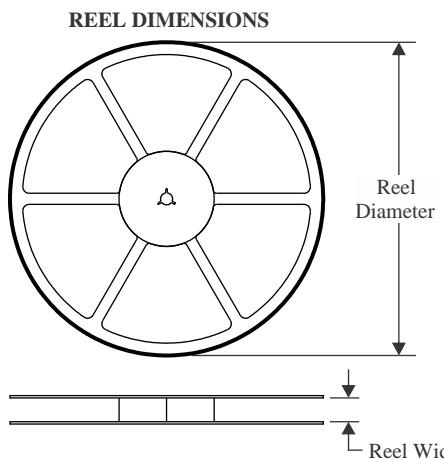
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54AS1004A, SN74AS1004A :**

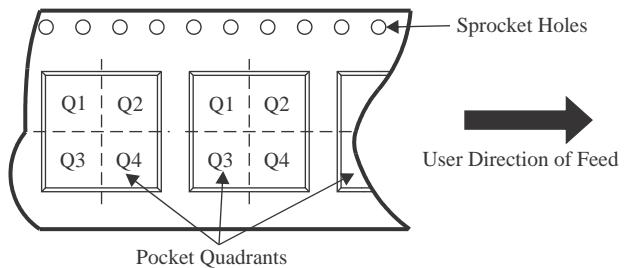
- Catalog : [SN74AS1004A](#)
- Military : [SN54AS1004A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

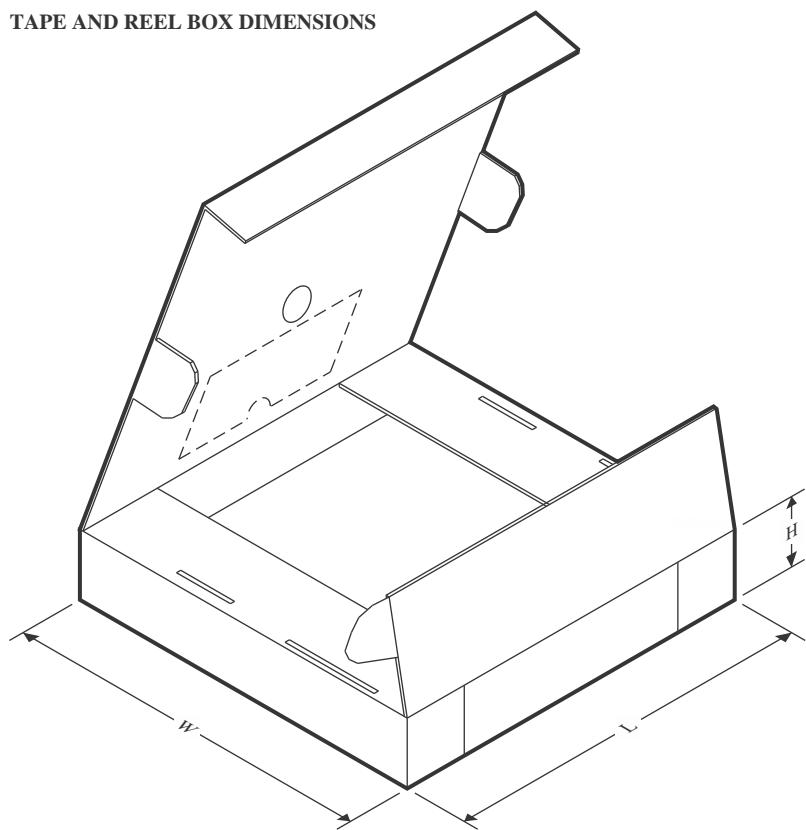
**TAPE AND REEL INFORMATION**


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


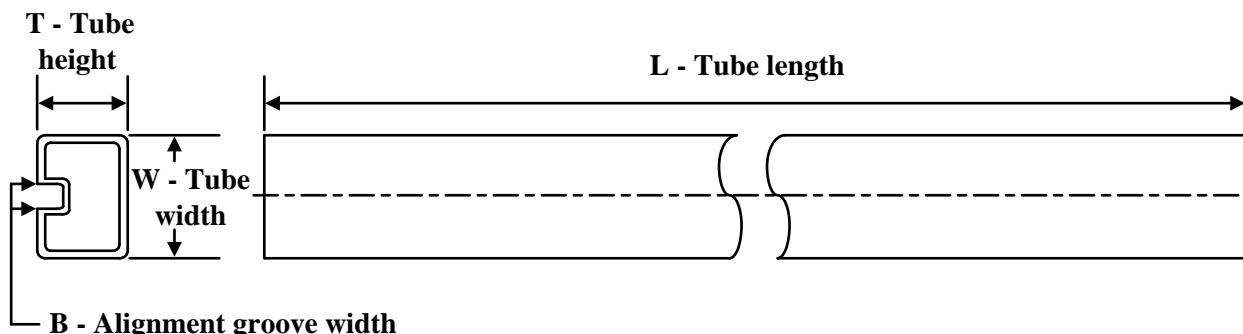
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS1004NSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74AS1004ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74AS1004ANSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS1004NSR	SOP	NS	14	2000	353.0	353.0	32.0
SN74AS1004ADR	SOIC	D	14	2500	353.0	353.0	32.0
SN74AS1004ANSR	SOP	NS	14	2000	353.0	353.0	32.0

**TUBE**


\*All dimensions are nominal

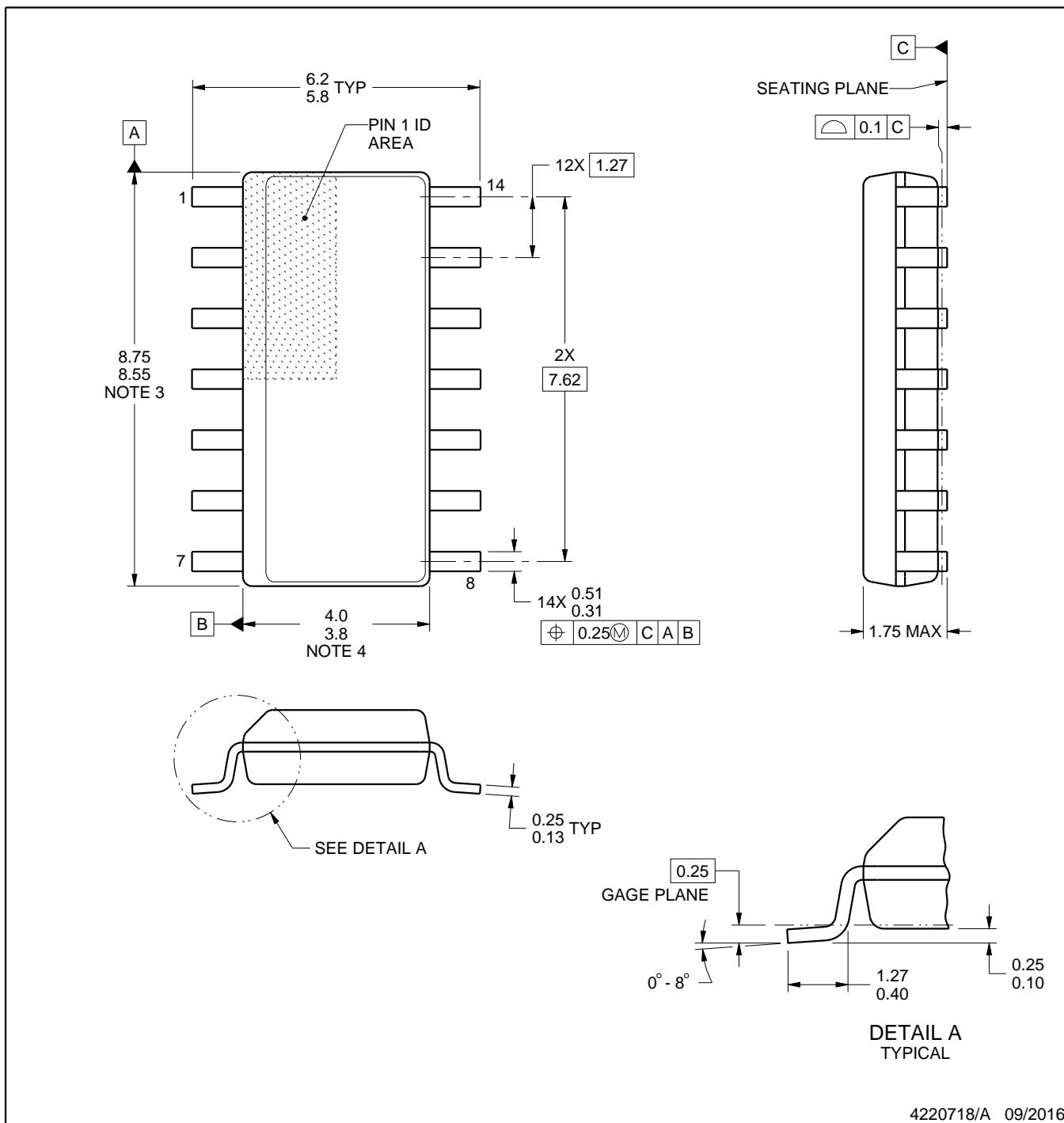
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-88729012A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8872901DA	W	CFP	14	25	506.98	26.16	6220	NA
SN74ALS1004D	D	SOIC	14	50	506.6	8	3940	4.32
SN74ALS1004D.A	D	SOIC	14	50	506.6	8	3940	4.32
SN74ALS1004N	N	PDIP	14	25	506	13.97	11230	4.32
SN74ALS1004N	N	PDIP	14	25	506	13.97	11230	4.32
SN74ALS1004N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74ALS1004N.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN.A	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN.B	N	PDIP	14	25	506	13.97	11230	4.32
SN74AS1004AN.B	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54AS1004AFK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54AS1004AFK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54AS1004AW	W	CFP	14	25	506.98	26.16	6220	NA
SNJ54AS1004AW.A	W	CFP	14	25	506.98	26.16	6220	NA

# PACKAGE OUTLINE

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



## NOTES:

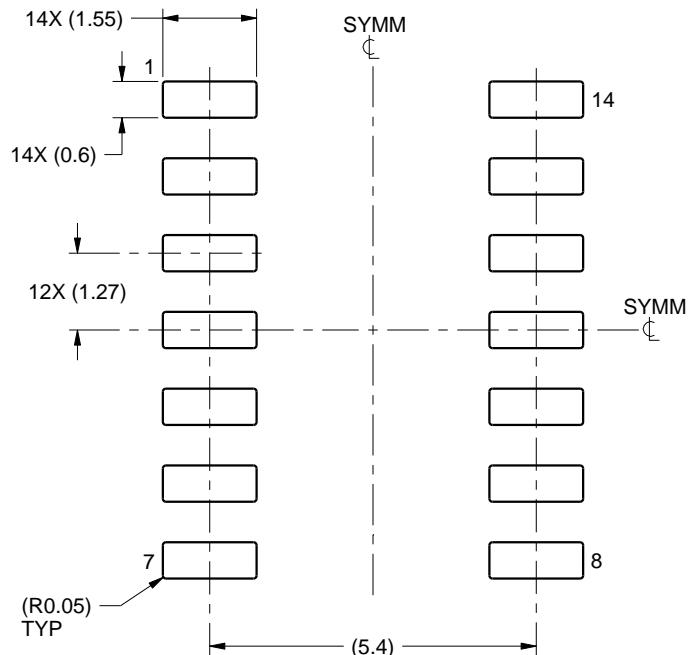
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

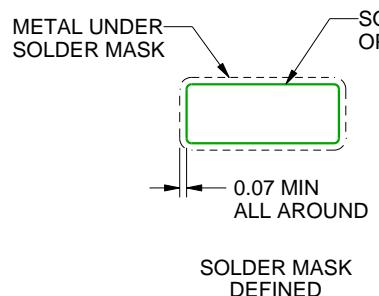
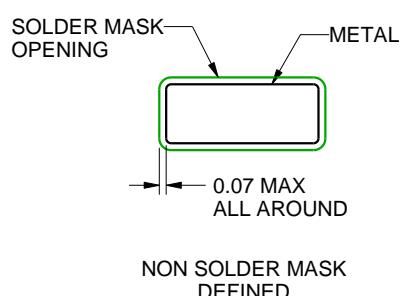
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

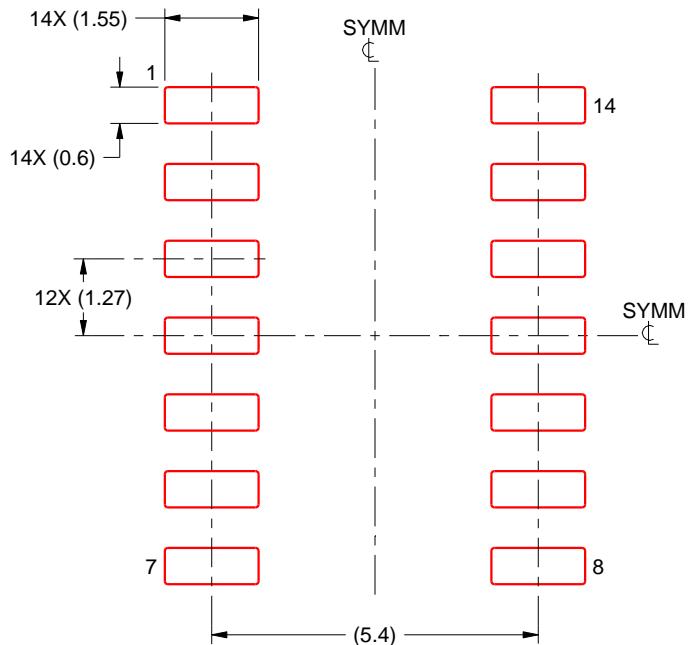
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

## PLASTIC SMALL-OUTLINE PACKAGE

**14-PINS SHOWN**

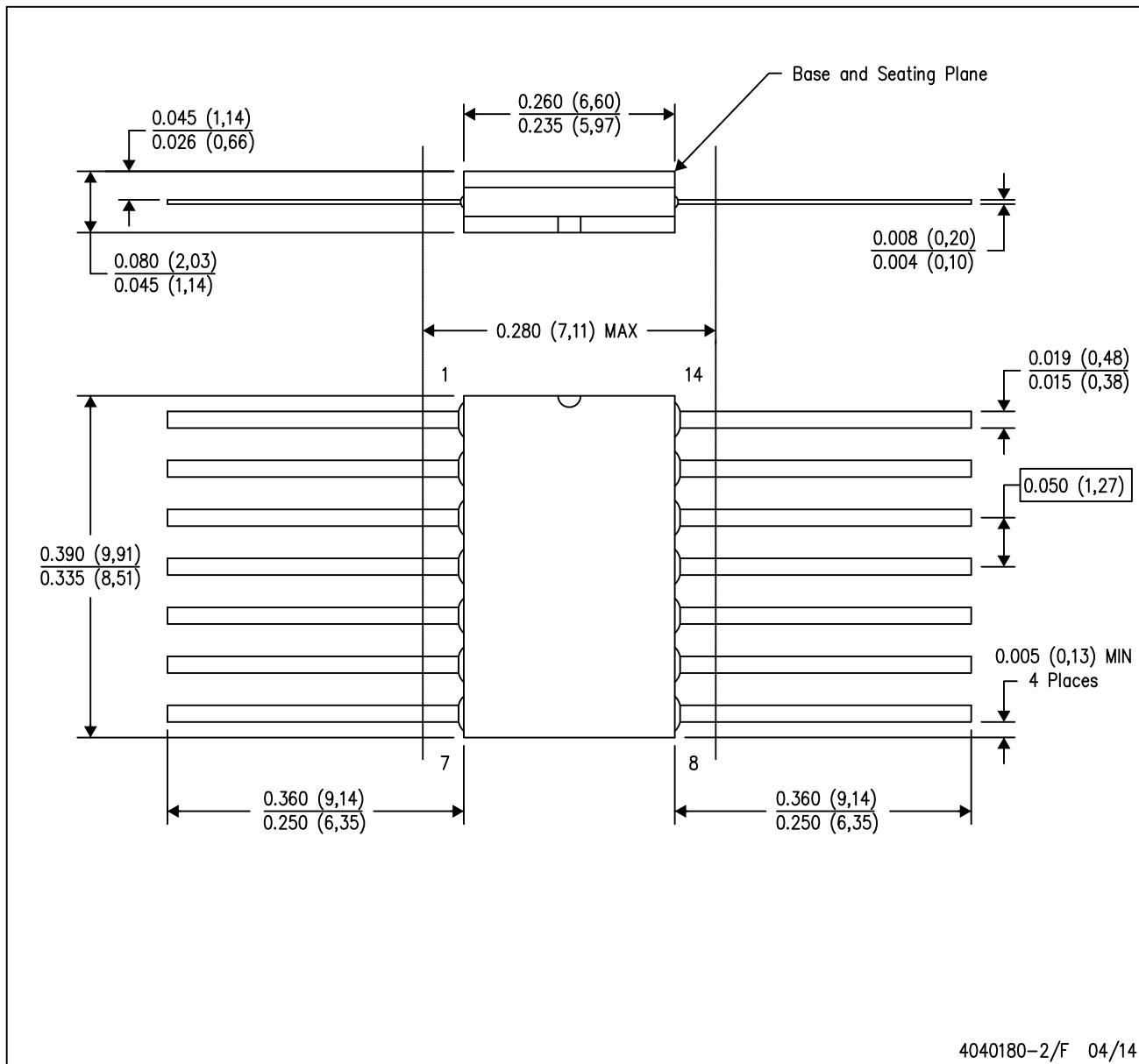


NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14

4040180-2/F 04/14

# GENERIC PACKAGE VIEW

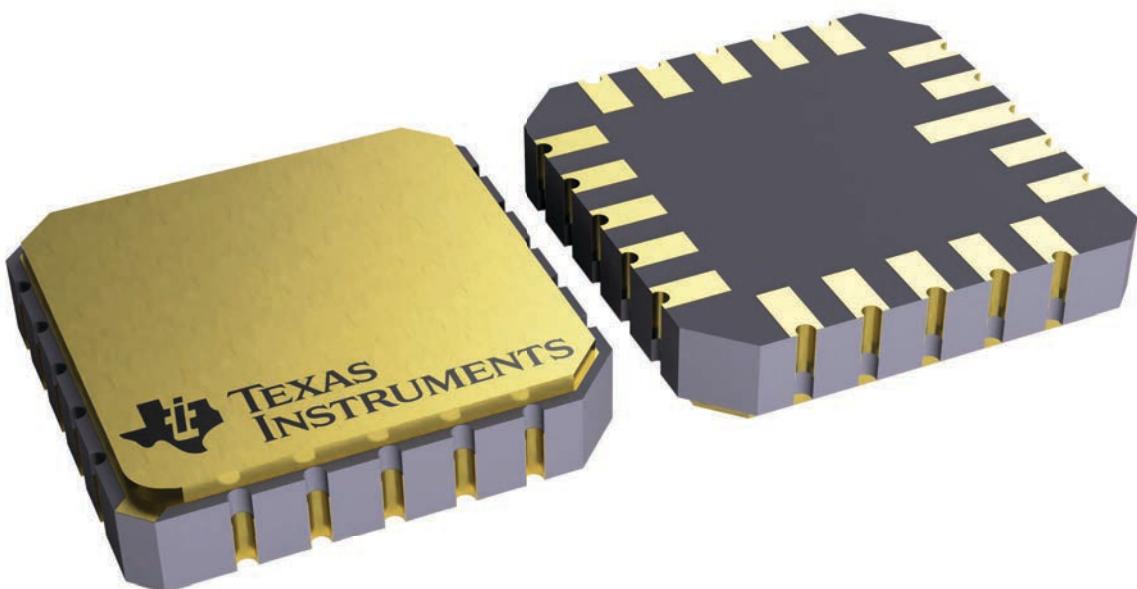
**FK 20**

**LCCC - 2.03 mm max height**

**8.89 x 8.89, 1.27 mm pitch**

**LEADLESS CERAMIC CHIP CARRIER**

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



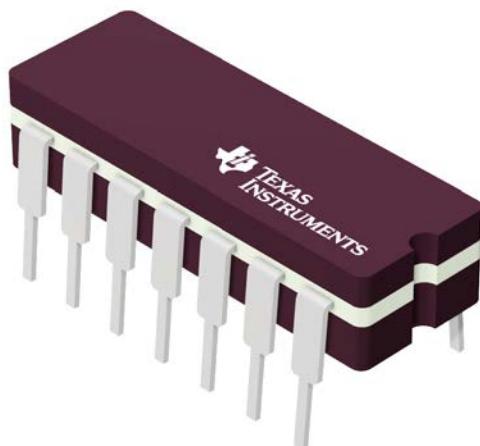
4229370VA\

# GENERIC PACKAGE VIEW

**J 14**

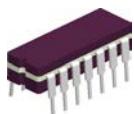
**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

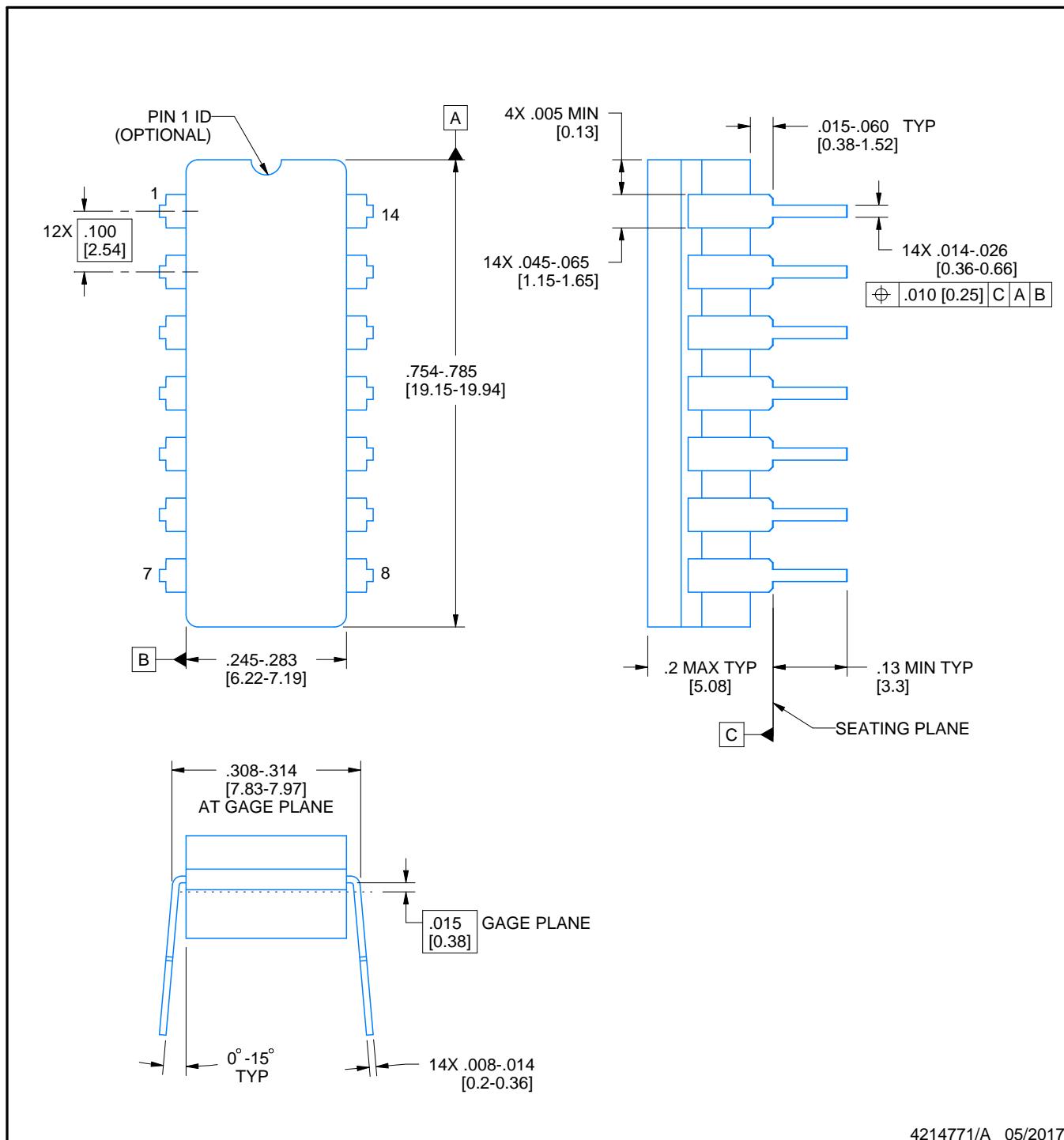


# PACKAGE OUTLINE

J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

## NOTES:

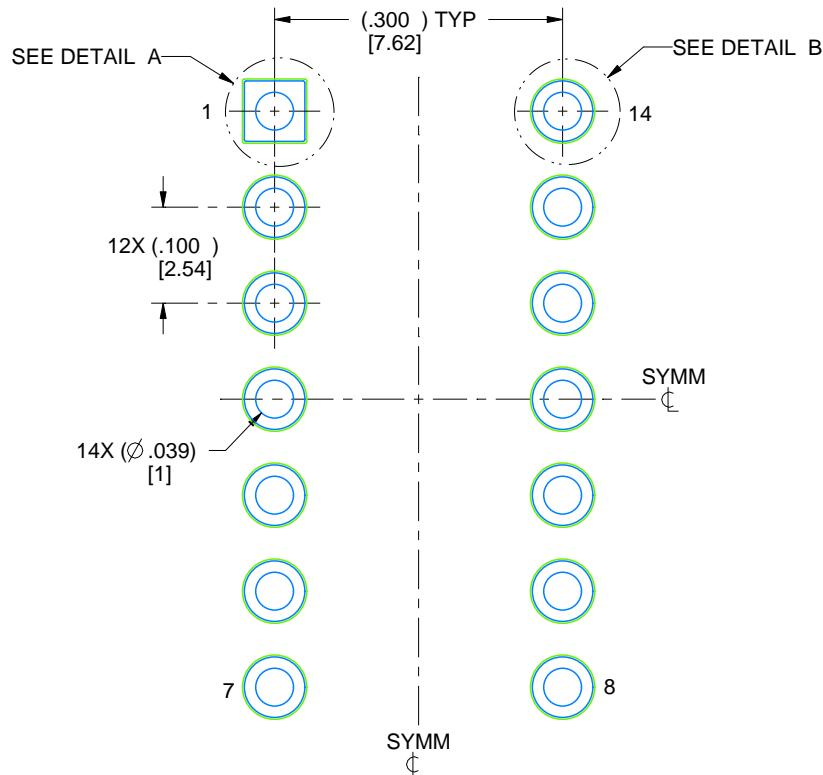
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

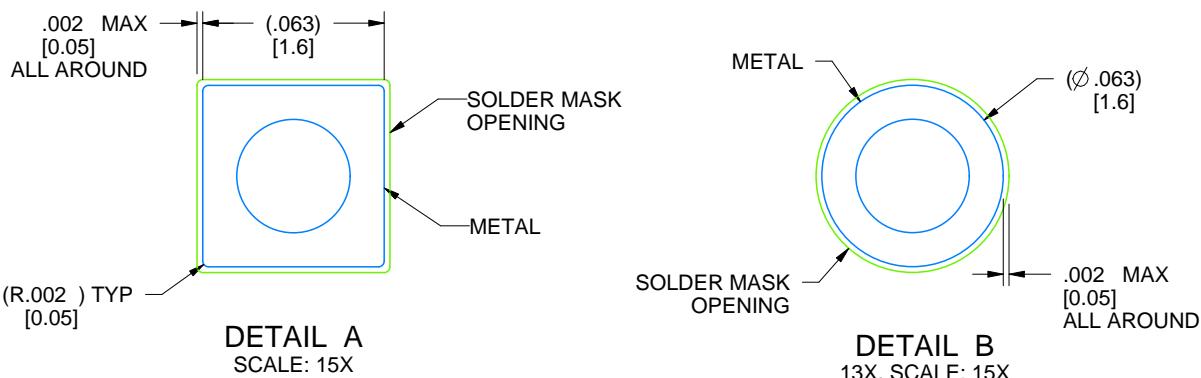
J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



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